



## Film Capacitors

### EMI Suppression Capacitors (MKP)

**Series/Type:** B32921C/D ... B32928C/D

**Date:** December 2012

### Typical applications

- X2 class for interference suppression
- "Across the line" applications

### Climatic

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1): 40/105/56

### Construction

- Dielectric: polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

### Features

- Very small dimensions
- Self-healing properties
- RoHS-compatible
- Halogen-free capacitors available on request

### Terminals

- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

### Marking

Manufacturer's logo, lot number, date code, rated capacitance (coded), cap. tolerance (code letter), rated AC voltage, series number, sub-class (X2), dielectric code (MKP), climatic category, passive flammability category, approvals.

### Delivery mode

Bulk (untaped)

Taped (Ammo pack or reel)

For taping details, refer to chapter

"Taping and packing"

### Dimensional drawing



Dimensions in mm

Lead spacing $e \pm 0.4$	Lead diameter $d_1$	Type
10	0.6	B32921
15	0.8	B32922
22.5	0.8	B32923
27.5	0.8	B32924
37.5	1.0	B32926
52.5	1.2	B32928

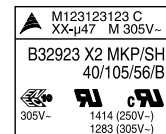
### Marking Examples

$e = 10$  mm



KMK0820-B

$e \geq 15$  mm/ $C_R \leq 1 \mu F$



KMK0821-J

$e = 22.5, 27.5, 37$  mm/ $C_R > 1 \mu F$



KMK0822-S

### Approvals

Approval marks	Standards	Certificate
	EN 60384-14, IEC 60384-14	40010694
	UL 1414 / UL 1283	E97863 / E157153
	CSA C22.2 No.1 / No. 8	E97863 / E157153 (approved by UL)
	CQC (GB/T 14472-1998)	CQC06001015331 / CQC06001016454



**Overview of available types**

Lead spacing	10 mm	15 mm	22.5 mm	27.5 mm	37.5 mm	52.5 mm
Type	B32921	B32922	B32923	B32924	B32926	B32928
$C_R$ ( $\mu F$ )						
0.010						
0.022						
0.033						
0.047						
0.068						
0.10						
0.15						
0.22						
0.33						
0.47						
0.68						
1.0						
1.5						
2.2						
3.3						
3.9						
4.7						
5.6						
6.8						
8.2						
10						
15						
20						
25						
30						


**B32921C/D ... B32928C/D**
**X2 / 305 V AC**
**Ordering codes and packing units**

Lead spacing mm	C <sub>R</sub> μF	Max. dimensions w × h × l mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./ MOQ	Untaped pcs./ MOQ
10	0.010	4.0 × 9.0 × 13.0	B32921C3103+*** ◆	4000	6800	4000
	0.022	4.0 × 9.0 × 13.0	B32921C3223+*** ◆	4000	6800	4000
	0.033	4.0 × 9.0 × 13.0	B32921C3333+*** ◆	4000	6800	4000
	0.047	5.0 × 11.0 × 13.0	B32921C3473+*** ◆	3320	5200	4000
	0.068	6.0 × 12.0 × 13.0	B32921C3683+***	2720	4400	4000
	0.10	6.0 × 12.0 × 13.0	B32921C3104M***	2720	4400	4000
15	0.033	5.0 × 10.5 × 18.0	B32922C3333K***	4680	5200	4000
	0.047	5.0 × 10.5 × 18.0	B32922C3473K***	4680	5200	4000
	0.068	5.0 × 10.5 × 18.0	B32922C3683K*** ◆	4680	5200	4000
	0.10	5.0 × 10.5 × 18.0	B32922C3104+*** ◆	4680	5200	4000
	0.15	6.0 × 12.0 × 18.0	B32922C3154+*** ◆	3840	4400	4000
	0.22	7.0 × 12.5 × 18.0	B32922C3224+*** ◆	3320	3600	4000
	0.33	8.0 × 14.0 × 18.0	B32922C3334M*** ◆	2920	3000	2000
	0.33	8.5 × 14.5 × 18.0	B32922D3334K***	2720	2800	2000
	0.47	9.0 × 17.5 × 18.0	B32922C3474+*** ◆	2560	2800	2000
0.68	11.0 × 18.5 × 18.0	B32922C3684+*** ◆	—	2200	1000	
22.5	0.22	6.0 × 15.0 × 26.5	B32923C3224+***	2720	2800	2880
	0.33	6.0 × 15.0 × 26.5	B32923C3334M***	2720	2800	2880
	0.33	7.0 × 16.0 × 26.5	B32923D3334K***	2320	2400	2520
	0.47	8.5 × 16.5 × 26.5	B32923C3474+***	1920	2000	2040
	0.68	10.5 × 16.5 × 26.5	B32923C3684+***	1560	1600	2160
	1.0	11.0 × 20.5 × 26.5	B32923C3105+*** ◆	1480	1400	2040
	1.5	12.0 × 22.0 × 26.5	B32923C3155M***	—	—	1800
	2.2	14.5 × 29.5 × 26.5	B32923C3225+***	—	—	1040

**◆ Preferred type**

MOQ = Minimum Order Quantity, consisting of 4 packing units.

For new design, please refer to the B3292xE/F data sheet.

Further intermediate capacitance values on request.

**Composition of ordering code**

+ = Capacitance tolerance code:

M = ±20%

K = ±10%

\*\*\* = Packaging code:

289 = Ammo pack

189 = Reel

000 = Untaped (lead length 6 – 1 mm)

(Closer tolerances on request)

**Ordering codes and packing units**

Lead spacing mm	C <sub>R</sub> μF	Max. dimensions w × h × l mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./ MOQ	Untaped pcs./ MOQ
27.5	0.68	11.0 × 19.0 × 31.5	B32924C3684+***	–	1400	1280
	1.0	11.0 × 19.0 × 31.5	B32924C3105+***	–	1400	1280
	1.5	12.5 × 21.5 × 31.5	B32924C3155+*** ◆	–	1200	1120
	2.2	14.0 × 24.5 × 31.5	B32924C3225+***	–	–	1040
	3.3	16.0 × 32.0 × 31.5	B32924D3335K***	–	–	880
	3.3	18.0 × 27.5 × 31.5	B32924C3335M***	–	–	800
	4.7	18.0 × 33.0 × 31.5	B32924C3475M***	–	–	800
	4.7	21.0 × 31.0 × 31.5	B32924D3475K***	–	–	720
	5.6	22.0 × 36.5 × 31.5	B32924C3565+***	–	–	784
37.5	2.2	14.0 × 25.0 × 41.5	B32926C3225+***	–	–	1380
	3.3	16.0 × 28.5 × 41.5	B32926C3335+***	–	–	800
	3.9	16.0 × 28.5 × 41.5	B32926C3395+***	–	–	800
	4.7	18.0 × 32.5 × 41.5	B32926C3475+***	–	–	720
	5.6	18.0 × 32.5 × 41.5	B32926C3565+***	–	–	720
	6.8	20.0 × 39.5 × 41.5	B32926C3685+***	–	–	640
	8.2	20.0 × 39.5 × 41.5	B32926C3825+***	–	–	640
	10	28.0 × 42.5 × 41.5	B32926C3106+***	–	–	440
	15	30.0 × 45.0 × 42.0	B32926C3156M***	–	–	200
	15	33.0 × 48.0 × 42.0	B32926D3156+***	–	–	180
52.5	20	30.0 × 45.0 × 57.5	B32928C3206+***	–	–	280
	25	35.0 × 50.0 × 57.5	B32928C3256+***	–	–	108
	30	35.0 × 50.0 × 57.5	B32928C3306M***	–	–	108

**◆ Preferred type**

MOQ = Minimum Order Quantity, consisting of 4 packing units.

For new design, please refer to the B3292xE/F data sheet.

Further intermediate capacitance values on request.

**Composition of ordering code**

+ = Capacitance tolerance code:

M = ±20%

K = ±10%

\*\*\* = Packaging code:

289 = Ammo pack

189 = Reel

000 = Untaped (lead length 6 –1 mm)

(Closer tolerances on request)

For the following types the safety approvals are pending:

B32926C3156M000, B32926D3156K000, B32926D3156M000

B32928C3206K000, B32928C3206M000, B32928C3256K000, B32928C3256M000,

B32928C3306M000



B32921C/D ... B32928C/D

X2 / 305 V AC

### Technical data

Max. operating temperature $T_{op,max}$	+110 °C			
Dissipation factor $\tan \delta$ (in $10^{-3}$ ) at 20 °C (upper limit values)		$C_R \leq 0.1 \mu F$	$0.1 \mu F < C_R \leq 2.2 \mu F$	$C_R > 2.2 \mu F$
	at 1 kHz	1.0	1.0	2.0
	100 kHz	5.0	–	–
Insulation resistance $R_{ins}$ or time constant $\tau = C_R \cdot R_{ins}$ at 20 °C, rel. humidity $\leq 65\%$ (minimum as-delivered values)	$C_R \leq 0.33 \mu F$	$C_R > 0.33 \mu F$		
	100 000 M $\Omega$	30 000 s		
DC test voltage	2121 V, 2 s			
Passive flammability category to IEC 40 (CO) 752	B			
Maximum continuous DC voltage $V_{DC}$	630 V			
Maximum continuous AC voltage $V_{AC}$	310 V (50/60 Hz)			
Rated AC voltage (IEC 60384-14)	305 V (50/60 Hz)			
Operating AC voltage $V_{op}$ at high temperature	$T_A \leq 110 \text{ °C}$	$V_{op} = V_{AC}$ (continuously)		
	$T_A \leq 110 \text{ °C}$	$V_{op} = 1.25 \cdot V_{AC}$ (1000 h)		
Damp heat test	56 days / 40 °C / 93% relative humidity			
Limit values after damp heat test	Capacitance change $ \Delta C/C  \leq 5\%$			
	Dissipation factor change $\Delta \tan \delta \leq 0.5 \cdot 10^{-3}$ (at 1 kHz)			
	Insulation resistance $R_{ins} \leq 1.0 \cdot 10^{-3}$ (at 10 kHz)			
	or time constant $\tau = C_R \cdot R_{ins} \geq 50\%$ of minimum as-delivered values			



### Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/μs.

"k<sub>0</sub>" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V<sup>2</sup>/μs.

*Note:*

*The values of dV/dt and k<sub>0</sub> provided below must not be exceeded in order to avoid damaging the capacitor.*

### dV/dt and k<sub>0</sub> values

Lead spacing	10 mm	15 mm	22.5 mm	27.5 mm	37.5 mm	52.5 mm
dV/dt in V/μs	475	340	170	120	80	50
k <sub>0</sub> in V <sup>2</sup> /μs	408500	292400	146200	103200	68800	43200

### Impedance Z versus frequency f

(typical values)





B32921C/D ... B32928C/D

X2 / 305 V AC

## Mounting guidelines

### 1 Soldering

#### 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

#### 1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A.

Conditions:

Series	Solder bath temperature	Soldering time
MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP (lead spacing > 7.5 mm)		
MKT boxed (case 2.5 × 6.5 × 7.2 mm)		5 ±1 s
MKP (lead spacing ≤ 7.5 mm)		< 4 s
MKT uncoated (lead spacing ≤ 10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)





Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
$\tan \delta$	As specified in sectional specification



B32921C/D ... B32928C/D

X2 / 305 V AC

### 1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{max}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
  - diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
  - MKP/MFP 110 °C
  - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

#### Uncoated capacitors

For uncoated MKT capacitors with lead spacings  $\leq 10$  mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Application note for X1 / X2 EMI capacitors



## Application note for the different possible X1 / X2 positions

### In series with the powerline (i.e. capacitive power supply)

Typical Applications:

- Power meters
- ECUs for white goods and household appliances
- Different sensor applications
- Severe ambient conditions

#### Basic circuit



#### Required features

- High capacitance stability over the lifetime
- Narrow tolerances for a controlled current supply

#### Recommended EPCOS product series

- B3293\* (305 V AC) heavy duty with EN approval for X2 (UL Q1/2010)
- B3292\*7 (305 V AC) improved standard series, approved as X2
- B3291\* (330 V AC), approved as X1
- B3265\* MKP series standard MKP capacitor without safety approvals
- B3267\*L MKP series standard MKP capacitor without safety approvals

### In parallel with the powerline

Typical Applications:

Standard X2 are used parallel over the mains for reducing electromagnetic interferences coming from the grid. For such purposes they must meet the applicable EMC directives and standards.

#### Basic circuit



#### Required features

- Standard safety approvals (ENEC, UL, CSA, CQC)
- High pulse load capability
- Withstand surge voltages

#### Recommended EPCOS product series

- B3292\*C/D (305 V AC) standard series, approved as X2
- B3292\*E/F (305 V AC) miniaturized series (> 2.2  $\mu$ F), approved as X2
- B3291\* (330 V AC), approved as X1



B32921C/D ... B32928C/D

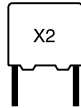
X2 / 305 V AC

### Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

### Design of EMI Capacitors

EPCOS EMI capacitors use polypropylene (PP) film metalized with a thin layer of Zinc (Zn). The following key points have made this design suitable to IEC/UL testing, holding a minimum size.

- Overvoltage AC capability with very high temperature Endurance test of IEC60384-14 (3<sup>rd</sup> edition, 2005-07) / UL60384-14 (1st edition, 2009-04) must be performed at  $1.25 \times V_R$  at maximum temperature, during 1000 hours, with a capacitance drift less than 10%.
- Higher breakdown voltage withstanding if compared to other film metallizations, like Aluminum. IEC60384-14 (3<sup>rd</sup> edition, 2005-07) / UL60384-14 (1st edition, 2009-04) establishes high voltage tests performed at  $4.3 \times V_R - 1$  minute, impulse testing at 2500 V for  $C = 1 \mu F$  and active flammability tests.
- Damp heat steady state: 40 °C/ 93% RH / 56 days. (without voltage or current load)

### Effect of humidity on capacitance stability

Long contact of a film capacitor with humidity can produce irreversible effects. Direct contact with liquid water or excess exposure to high ambient humidity or dew will eventually remove the film metallization and thus destroy the capacitor. Plastic boxed capacitors must be properly tested in the final application at the worst expected conditions of temperature and humidity in order to check if any parameter drift may provoke a circuit malfunction.

In case of penetration of humidity through the film, the layer of Zinc can be degraded, specially under AC operation (change of polarity), accelerated by the temperature, provoking an increment of the serial resistance of the electrode and eventually a reduction of the capacitance value. For DC operation, the parameter drift is much less.

Plastic boxes and resins can not protect 100% against humidity. Metal enclosures, resin potting or coatings or similar measures by customers in their applications will offer additional protection against humidity penetration.


**B32921C/D ... B32928C/D**
**X2 / 305 V AC**
**Symbols and terms**

Symbol	English	German
$\alpha$	Heat transfer coefficient	Wärmeübergangszahl
$\alpha_C$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
$\beta_C$	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
C	Capacitance	Kapazität
$C_R$	Rated capacitance	Nennkapazität
$\Delta C$	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
$\Delta t$	Time interval	Zeitintervall
$\Delta T$	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta \tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
$\Delta V$	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
$f_1$	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
$f_2$	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
$f_r$	Resonant frequency	Resonanzfrequenz
$F_D$	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
$F_T$	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
$I_C$	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)

Symbol	English	German
$I_{RMS}$	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
$i_z$	Capacitance drift	Inkonstanz der Kapazität
$k_0$	Pulse characteristic	Impuls Kennwert
$L_S$	Series inductance	Serieninduktivität
$\lambda$	Failure rate	Ausfallrate
$\lambda_0$	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
$\lambda_{test}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
$P_{diss}$	Dissipated power	Abgegebene Verlustleistung
$P_{gen}$	Generated power	Erzeugte Verlustleistung
$Q$	Heat energy	Wärmeenergie
$\rho$	Density of water vapor in air	Dichte von Wasserdampf in Luft
$R$	Universal molar constant for gases	Allg. Molarkonstante für Gas
$R$	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
$R_i$	Internal resistance	Innenwiderstand
$R_{ins}$	Insulation resistance	Isolationswiderstand
$R_P$	Parallel resistance	Parallelwiderstand
$R_S$	Series resistance	Serienwiderstand
$S$	severity (humidity test)	Schärfegrad (Feuchtest)
$t$	Time	Zeit
$T$	Temperature	Temperatur
$\tau$	Time constant	Zeitkonstante
$\tan \delta$	Dissipation factor	Verlustfaktor
$\tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$\tan \delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlustfaktors
$\tan \delta_S$	Series component of dissipation factor	Serienanteil des Verlustfaktors
$T_A$	Ambient temperature	Umgebungstemperatur
$T_{max}$	Upper category temperature	Obere Kategorietemperatur
$T_{min}$	Lower category temperature	Untere Kategorietemperatur
$t_{OL}$	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
$T_{op}$	Operating temperature	Betriebstemperatur
$T_R$	Rated temperature	Nenntemperatur
$T_{ref}$	Reference temperature	Referenztemperatur
$t_{SL}$	Reference service life	Referenz-Lebensdauer
$V_{AC}$	AC voltage	Wechselspannung


**B32921C/D ... B32928C/D**
**X2 / 305 V AC**

Symbol	English	German
$V_C$	Category voltage	Kategorie <span>spannung</span>
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechsel <span>spannung</span>
$V_{CD}$	Corona-discharge onset voltage	Teilentlade-Einsatz <span>spannung</span>
$V_{ch}$	Charging voltage	Ladespannung
$V_{DC}$	DC voltage	Gleichspannung
$V_{FB}$	Fly-back capacitor voltage	Spannung (Flyback)
$V_i$	Input voltage	Eingangsspannung
$V_o$	Output voltage	Ausgangssspannung
$V_{op}$	Operating voltage	Betriebsspannung
$V_p$	Peak pulse voltage	Impuls-Spitzen <span>spannung</span>
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
$V_R$	Rated voltage	Nennspannung
$\hat{V}_R$	Amplitude of rated AC voltage	Amplitude der Nenn-Wechsel <span>spannung</span>
$V_{RMS}$	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechsel <span>spannung</span>
$V_{SC}$	S-correction voltage	Spannung bei Anwendung "S-correction"
$V_{sn}$	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
$Z$	Impedance	Scheinwiderstand
$e$	Lead spacing	Rastermaß



## Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet ([www.epcos.com/material](http://www.epcos.com/material)). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
6. Unless otherwise agreed in individual contracts, **all orders are subject to the current version of the "General Terms of Delivery for Products and Services in the Electrical Industry" published by the German Electrical and Electronics Industry Association (ZVEI)**.
7. The trade names EPCOS, BAOKE, Alu-X, CeraDiode, CeraLink, CSMP, CSSP, CTVS, DeltaCap, DigiSiMic, DSSP, FilterCap, FormFit, MiniBlue, MiniCell, MKD, MKK, MLSC, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SIP5D, SIP5K, ThermoFuse, WindCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at [www.epcos.com/trademarks](http://www.epcos.com/trademarks).

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: [org@lifeelectronics.ru](mailto:org@lifeelectronics.ru)